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APPLICANTS Yoshihisa Saimoto, Nagoya-shi Aichi, JAPAN; Makoto Kataoka, Sodegaura-shi Chiba, JAPAN; Masafumi Miyakawa, Nagoya-shi Aichi, JAPAN; Shinichi Hayakawa, Nagoya-shi Aichi, JAPAN; Kouji Igarashi, Nagoya-shi Aichi, JAPAN;				
** CONTINUING DATA ***** This application is a 371 of PCT/JP03/03705 03/26/2003				
** FOREIGN APPLICATIONS ***** JAPAN 2002-090493 03/28/2002				
Foreign Priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions <input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after met Allowance Verified and Acknowledged _____ Examiner's Signature Initials		STATE OR COUNTRY JAPAN	SHEETS DRAWING	TOTAL CLAIMS 4
				INDEPENDENT CLAIMS 2
ADDRESS 21839				
TITLE Pressure sensitive adhesive film for protection of semiconductor wafer surface and method of protecting semiconductor wafer with the pressure sensitive adhesive film				
FILING FEE RECEIVED 920	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	